

SILICON DARLINGTON POWER TRANSISTORS

NPN silicon Darlington transistors in a SOT186 envelope with an electrically insulated mounting base.
PNP complements are BD644F, BD646F, BD648F, BD650F and BD652F.

QUICK REFERENCE DATA

		BD643F	645F	647F	649F	651F
Collector-base voltage (open emitter)	V_{CBO} max.	60	80	100	120	140 V
Collector-emitter voltage (open base)	V_{CEO} max.	45	60	80	100	120 V
Collector current (DC)	I_C max.	8				A
Total power dissipation at $T_h \leq 25^\circ\text{C}$	P_{tot} max.	20				W
Junction temperature	T_j max.	150				$^\circ\text{C}$

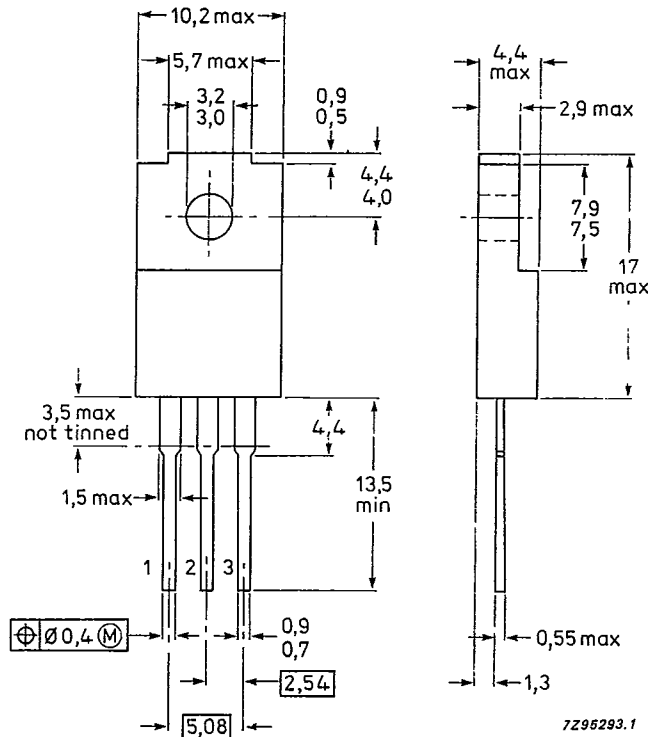
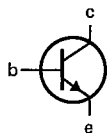
MECHANICAL DATA

Dimensions in mm

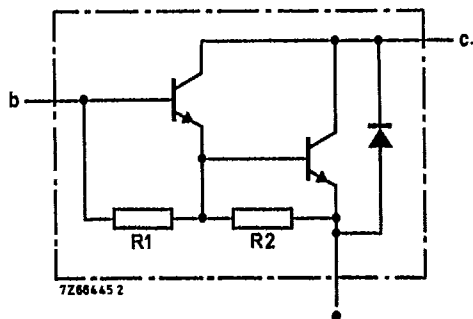
Fig.1 SOT186.

Pinning

- 1 = base
- 2 = collector
- 3 = emitter



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R1 typ. 4 k Ω
R2 typ. 100 k Ω

Fig. 2 Darlington circuit diagram.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

		BD643F	645F	647F	649F	651F
Collector-base voltage (open emitter)	V_{CBO} max.	60	80	100	120	140 V
Collector-emitter voltage (open base)	V_{CEO} max.	45	60	80	100	120 V
Emitter-base voltage (open collector)	V_{EBO} max.			5		V
Collector current (DC) (peak value)	I_C max.			8		A
	I_{CM} max.			12		A
Base current (DC)	I_B max.			150		mA
Total power dissipation at $T_h \leq 25$ °C (note 1)	P_{tot} max.			20		W
at $T_h \leq 25$ °C (note 2)	P_{tot} max.			32		W
Storage temperature range	T_{stg}			-65 to +150		°C
Junction temperature	T_j max.			150		°C

THERMAL RESISTANCE

From junction to internal heatsink	R_{th-jmb} =		1.6	K/W
From junction to external heatsink (note 1)	R_{th-j-h} =		6.3	K/W
From junction to external heatsink (note 2)	R_{th-j-h} =		3.9	K/W

INSULATION

Voltage allowed between all terminals and external heatsink (peak value)	V_{insul} max.		1000	V
Isolation capacitance from collector to external heatsink	C_{th} max.		12	pF

Notes

1. Mounted without heatsink compound and 30 ± 5 newtons pressure on centre of envelope.
2. Mounted with heatsink compound and 30 ± 5 newtons pressure on centre of envelope.

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CHARACTERISTICS

 $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

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Collector cut-off currents

 $I_E = 0; V_{CB} = V_{CE0\text{max}}$ I_{CBO} max. 0.1 mA $I_E = 0; V_{CB} = 1/2 V_{CB0\text{max}};$
 $T_j = 150\text{ }^\circ\text{C}$ I_{CBO} max. 1 mA $I_B = 0; V_{CE} = 1/2 V_{CE0\text{max}}$ I_{CEO} max. 0.2 mA

Emitter cut-off current

 $V_{BE} = 5\text{ V}; I_C = 0$ I_{EBO} max. 5 mA

Static forward current transfer ratio (note 1)

 $I_C = 0.5\text{ A}; V_{CE} = 3\text{ V}$ h_{FE} typ. 1900 1900 1900 1900 1900 $I_C = 4\text{ A}; V_{CE} = 3\text{ V}$ h_{FE} min. 750 — — — — $I_C = 3\text{ A}; V_{CE} = 3\text{ V}$ h_{FE} min. — 750 750 750 750 $I_C = 8\text{ A}; V_{CE} = 3\text{ V}$ h_{FE} typ. 1800 1800 1800 1800 1800

Collector-emitter saturation voltage (note 1)

 $I_C = 4\text{ A}; I_B = 16\text{ mA}$ V_{CEsat} max. 2 — — — V $I_C = 3\text{ A}; I_B = 12\text{ mA}$ V_{CEsat} max. — 2 2 2 2 V $I_C = 5\text{ A}; I_B = 50\text{ mA}$ V_{CEsat} max. 2.5 2.5 2.5 2.5 2.5 V

Base-emitter saturation voltage (note 1)

 $I_C = 5\text{ A}; I_B = 50\text{ mA}$ V_{BEsat} max. 3 3 3 3 3 V

Base-emitter voltage (note 1)

 $I_C = 4\text{ A}; V_{CE} = 3\text{ V}$ V_{BE} max. 2.5 — — — V $I_C = 3\text{ A}; V_{CE} = 3\text{ V}$ V_{BE} max. — 2.5 2.5 2.5 2.5 V

Common-emitter cut-off frequency

 $I_C = 4\text{ A}; V_{CE} = 3\text{ V}$ f_{hfe} typ. 50 — — — kHz $I_C = 3\text{ A}; V_{CE} = 3\text{ V}$ f_{hfe} typ. — 50 50 50 50 kHz

Small signal current gain

 $I_C = 4\text{ A}; V_{CE} = 3\text{ V}; f = 1\text{ MHz}$ h_{fe} typ. 10 — — — $I_C = 3\text{ A}; V_{CE} = 3\text{ V}; f = 1\text{ MHz}$ h_{fe} typ. — 10 10 10 10Forward bias second breakdown
collector current $V_{CE} = 50\text{ V}; t_p = 0.1\text{ s}$ $I_{(SB)}$ min. — 0.55 — A

Forward voltage

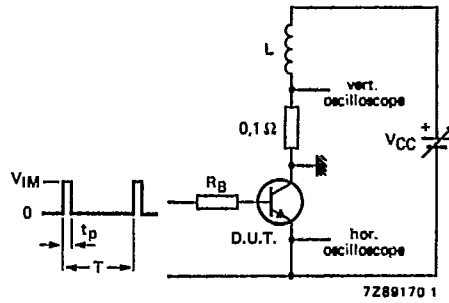
 $I_F = 3\text{ A}$ V_F typ. — 0.9 — V

Switching times

 $I_C = 3\text{ A}; I_{B\text{ on}} = I_{B\text{ off}} = 12\text{ mA}$ Turn on time t_{on} max. — 2 μs typ. — 1 μs Turn off time t_{off} max. — 10 μs typ. — 5 μs

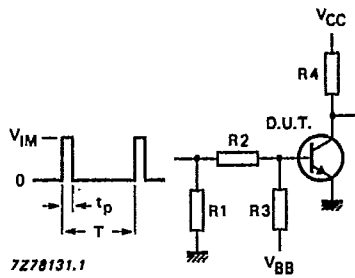
Note

1. To be measured under pulsed conditions, $t_p < 300\text{ }\mu\text{s}$; $\delta < 2\%$.



$V_{IM} = 12\text{ V}$
 $R_B = 270\ \Omega$
 $L = 5\text{ mH}$
 $I_{CC} = 4.5\text{ A}$
 $\delta = t_p/T \times 100\%$

Fig. 3 Test circuit for turn-off breakdown energy.



$V_{IM} = 10\text{ V}$
 $V_{CC} = 10\text{ V}$
 $-V_{BB} = 4\text{ V}$
 $R_1 = 56\ \Omega$
 $R_2 = 410\ \Omega$
 $R_3 = 560\ \Omega$
 $R_4 = 3\ \Omega$
 $t_r = t_f = 15\text{ ns}$
 $t_p = 10\ \mu\text{s}$
 $T = 500\ \mu\text{s}$

Fig. 4 Switching times test circuit.

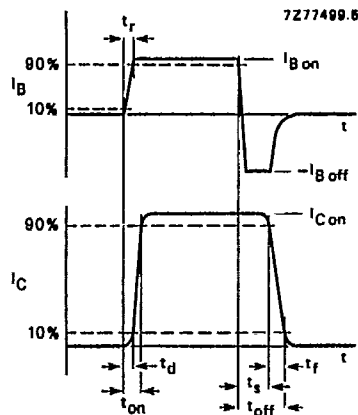
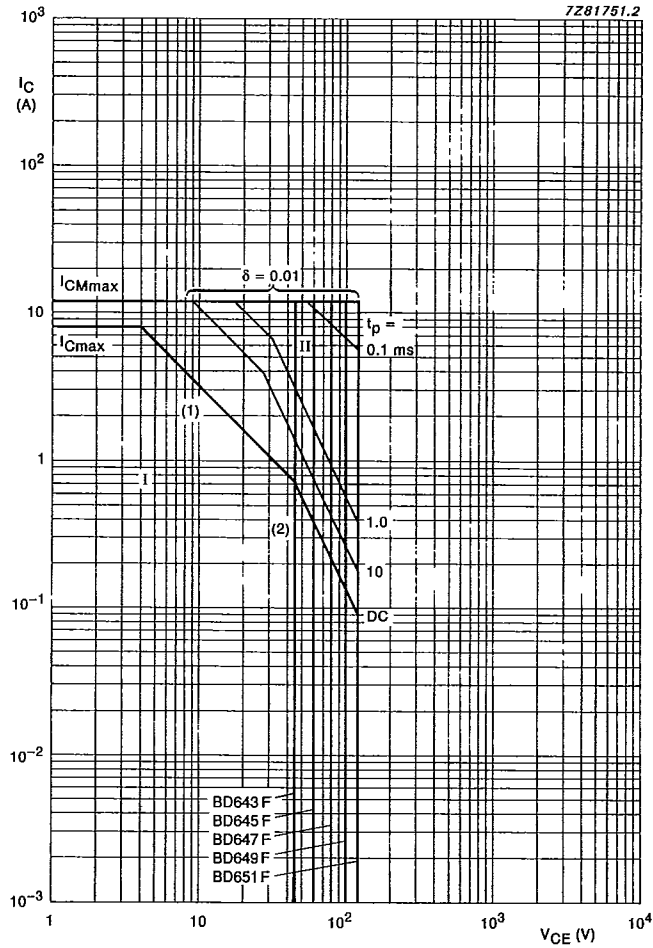


Fig. 5 Switching times waveforms.



- I Region of permissible DC operation.
- II Permissible extension for repetitive pulse operation.
- (1) $P_{tot\ max}$ and P_{peak} lines.
- (2) Second-breakdown limits.

Mounted with heatsink compound and 30 ± 5 newtons pressure on centre of envelope.

Fig.6 Safe Operating Area; $T_{amb} = 25\ ^\circ\text{C}$.

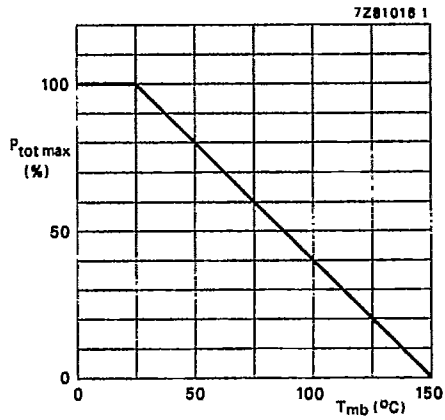


Fig. 7 Power derating curve.

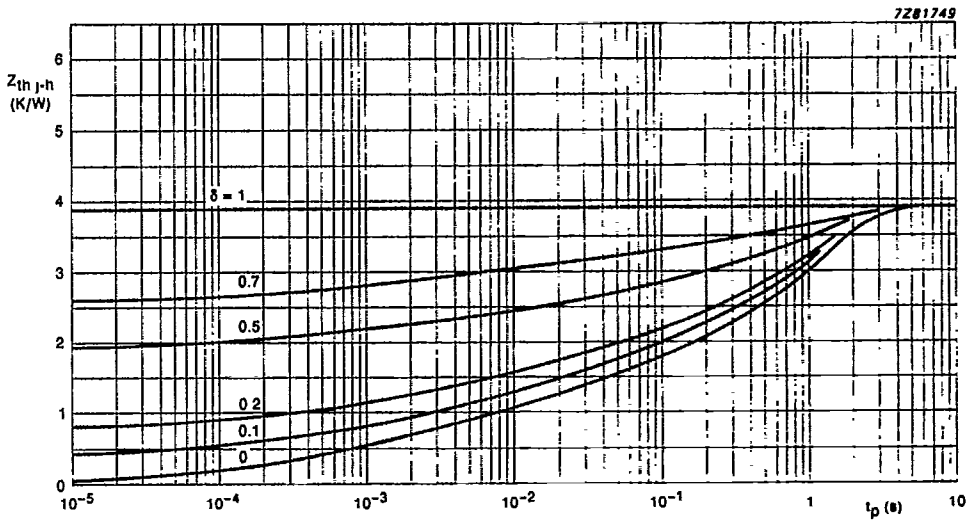


Fig. 8 Pulse power rating chart.

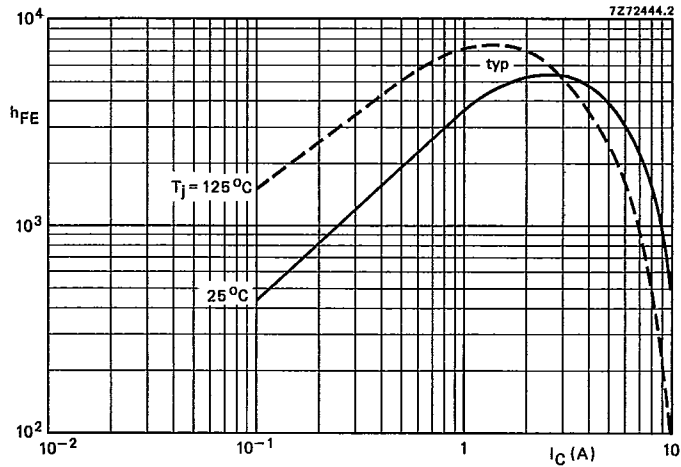


Fig. 9 Typical DC current gain curves; V_{CE} = 3 V.

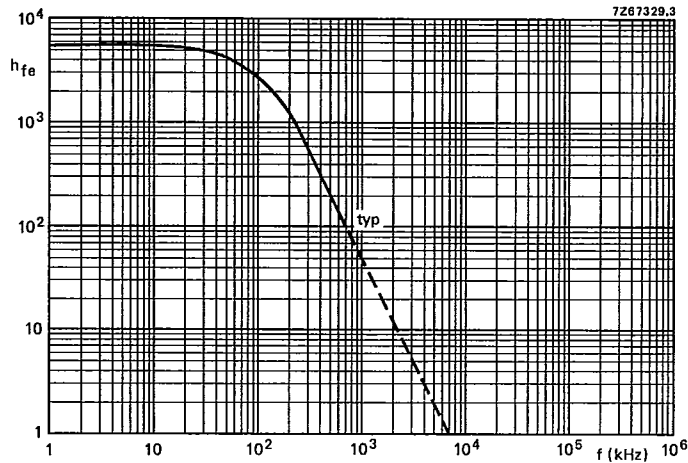


Fig. 10 Small signal current gain.

BD643F; 645F; 647F
BD649F; 651F

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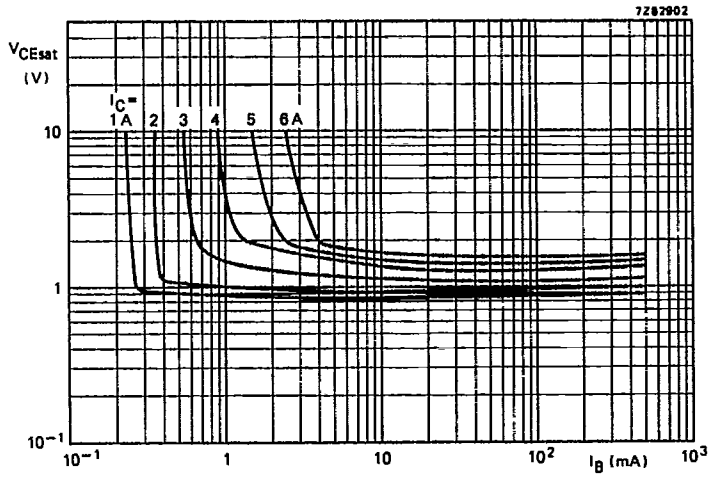


Fig. 11 Typical collector-emitter saturation voltage; $T_j = 25^\circ\text{C}$.